



#15/Response

PATENT

10/22/02

Shm H

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Jiang et al.

Serial No.: 09/483,712

Filed: January 14, 2000

For: CHIP-SCALE PACKAGES
HAVING ENCAPSULATED
CARRIER BONDS (as amended)

Examiner: M. Warren

Group Art Unit: 2815

Attorney Docket No.: 3815.1US (98-0670)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

October 2, 2002
Date of Deposit

Debra L. Mitchell
Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on date of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

Debra L. Mitchell
Typed/printed name of person whose signature is contained above

RECEIVED
OCT 10 2002
TECHNOLOGY CENTER 2800

RESPONSE

Box NON FEE – AMENDMENT
Commissioner for Patents
Washington, D.C. 20231

Sir:

The following remarks are filed in response to the Examiner's remarks in the Office Action mailed July 2, 2002, the three-month shortened statutory period for response to which expires on October 2, 2002.